As a below named inventor, I hereby declare that:

My residence/post ffice address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only ne name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

a patent is sought on the inven	tion entitled:
Semiconductor Device With De	posited Oxide
the specification of which is at	tached hereto unless the following box is checked:
() was filed on	as US Application No. or PCT International Application

I hereby state that I have reviewed and understood the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose all information which is material to patentability as defined in 37 CFR 1.56.

and was amended on

Foreign Application(s) and/or Claim of Foreign Priority

I hereby claim foreign priority benefits under Title 35. United States Code Section 119 of any foreign application(e) for patent or inventor(s) certificate listed below and have also identified below any foreign application for patent or inventor(s) certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NUMBER	DATE FILED	PRIORITY CLAIMED UN	DER 35 U.S.C. 119
			YES:	NO:
			YES:	NO:

Provisional Application

Number

I hereby claim the benefit under Title 36, United States Code Section 119(e) of any United States provisional application(s) listed below:

APPLICATION NUMBER	FIUNG DATE	

U. S. Priority Claim

I hereby claim the benefit under Title 35. United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35. United States Code Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.58(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION NUMBER	FILING DATE	STATUS (parented/pending/spendoned)

POWER OF ATTORNEY:

As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Customer Number 022879 Place Customer
Number Bar Code
Lebel here

Send Correspondence to:
HEWLETT-PACKARD COMPANY
Intellectual Property Administration
P.D. Box 272400
Fort Collins, Colorado 80627-2400

Direct Telephone Calls To:

Lucinda Auciello

(541) 715-7036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any petent issued thereon.

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DECLARATION AND POWER FOR PATENT APPLICATION (Sontinued)



Full Name of # 2 Joint invent	or: Frank R. Bryant		Citizenship: USA
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Inventor's Signature		Date	
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Full Name of # 5 joint Inven	ntor:		Citizenship:
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		Date	
Inventor's Signature	•		
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Inventor's Signature		Date	
Full Name of # 7 joint Inve	ntor:		Citizenship:
Residence:			
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Full Name of # 8 joint inve	ontor:		Citizenahip:
Residence:			
Post Office Address:			
		Date	
Inventor's Signature		ersu	